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# **DELO DUALBOND GE731**

## modified epoxy resin | 1C | UV- / VIS- / heat-curing

free of solvents | thixotropic

# **Special features of product**

# Typical area of use

- compliant with RoHS Directive 2015/863/EL
- passes ANSI/UL 94 HB Flame Test

ant with Rohs Directive 2015/863/EU	-40 -	180
AN 101 // 11 0 A 1 1 1 D E 1		

Curing		
Suitable lamp types	LED 365 nm, LED 400 nm	
Recommended light fixation time		
intensity 150 mW/cm² LED 365 nm	30	S
Recommended curing time		
at +130 °C in air convection oven	10	min
at +150 °C in air convection oven	5	min
Processing		
Adhesive application	needle-dispensable	
Conditioning time (typical)		
when stored in cold conditions in containers up to 1,000 ml	6	h
Processing time		
at rt approx. +23 °C	21	d
Storage life in unopened original container		
up to <= 1   at 0 °C to +10 °C	6	month(s)
at 0 °C to +25 °C	28	day(s)



Lec	hnica	I nro	nert	IPS
			PC: 0	

Transparency	translucent	
Color in cured condition in 1 mm layer thickness	yellowish	
Transparency in cured condition in 1 mm layer thickness	transparent	
Parameters		
Density DELO Standard 13   Liquid	1.09	g/cm³
Maximum curable layer thickness DELO Standard 20   Cardboard   365 nm   150 mW/cm²   60 s   Plus   24 h	4	mm
Shore hardness A  Based on DIN EN ISO 868   365 nm   150 mW/cm²   30 s   Plus   130 °C   10 min	43	
Coefficient of linear expansion  DELO Standard 26   TMA   Evaluation T: -20 °C - 150 °C   365 nm   150 mW/cm²   30 s   Plus   130 °C  10 min	274	ppm/K

#### Converting table

°F	$= (^{\circ}C \times 1.8) + 32$	1 MPa	= 145.04  ps
1 inch	= 25.4 mm	1 GPa	= 145.04 ksi
1 mil	= 25.4 µm	1 cP	= 1 mPa·s
1 oz	= 28.3495 g	1 N	= 0.225 lb

#### **General curing and processing information**

The curing time stated in the technical data was determined in the laboratory. It can vary depending on the adhesive quantity and component geometry and is therefore a reference value.

The heating time of the component geometry and is therefore a reference value.

The heating time of the components must be added to the actual curing time. It depends on component size and oven type. The specified curing temperature must be reached directly at the adhesive.

Increasing or decreasing the curing temperature and / or irradiation intensity and / or irradiation intensity shortens or prolongs the curing time and can lead to changed physical properties.

Parameters can vary for pure light curing, pure heat curing and a combination of light and heat curing.

Depending on the adhesive quantity used, exothermic reaction heat is generated which can lead to overheating. In this case, a lower curing temperature is to be selected.

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All curing or light fixation parameters depend on material thickness and absorption, adhesive layer thickness, lamp type and distance between lamp and adhesive layer.
Curing until final strength proceeds within 24 hours at room temperature.

Light and heat curing mechanisms can be used independently.

High temperatures during or after curing can lead to post-crosslinking of the adhesive which influences the physical properties of the bond.

Values measured after 24 h at approx. 23 °C / 50 % r.h., unless otherwise specified.



#### General

The data and information provided are based on tests performed under laboratory conditions. Reliable information about the behavior of the product under practical conditions and its suitability for a specific purpose cannot be concluded from this. It is the customer's responsibility to test the suitability of a product for the intended purpose by considering all specific requirements and by applying standards the customer deems suitable (e. g. DIN 2304-1). Type, physical and chemical properties of the materials to be processed with the product, as well as all actual influences occurring during transport, storage, processing and use, may cause deviations in the behavior of the product compared to its behavior under laboratory conditions. All data provided are typical average values or uniquely determined parameters measured under laboratory conditions. The data and information provided are therefore no guarantee for specific product properties or

the suitability of the product for a specific purpose. Nothing contained herein shall be construed to indicate the non-existence of any relevant patents or to constitute a permission, encouragement or recommendation to practice any development covered by any patents, without permission of the owner of this patent.

All products provided by DELO are subject to DELO's General Terms of Business. Verbal ancillary agreements are deemed not to exist.

#### Instructions for use

The instructions for use are available on www.DELO-adhesives.com.

We will be pleased to send them to you on demand.

### Occupational health and safety

See material safety data sheet.

## **Specification**

Nothing contained in this Technical Datasheet shall be interpreted as any express warranty or guarantee. This Technical Datasheet is for reference only and does not constitute a product specification. Please ask our responsible Sales Engineer for the applicable product specification which includes defined ranges. DELO is neither liable for any values and content of this Technical Datasheet nor for oral or written recommendations regarding the use, unless otherwise agreed in writing. This limitation of liability is not applicable for damages resulting from intent, gross negligence or culpable breach of cardinal obligations, nor shall it apply in case of death or personal injury or in case of liability under any applicable compulsory law.

CONTACT

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CURING